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Name of conveying party(ies):	Name and address of receiving party(ies)
John W. Regnier 6-25-02	Name: Micron Technology, Inc.
	Internal Address:
Additional name(s) of conveying party(ies) Additional name(s) of conveying party(ies) Yes X	Street Address: No Micron Technology, Inc. 8000 S. Federal Way
3. Nature of Conveyance:	,
x Assignment Merger	
Security Agreement Change of Name	City: Boise
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Execution Date: June 12, 2002	Additional name(s) & Yes X No address(es) attached:
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the A. Patent Application No.(s): 10/122,381	B. Patent No.(s):
Additional numbers at	tached? Yes x No
Name and address of party to whom correspondence concerning document should be mailed:	e 6. Total number of applications and patents involved:1
Name: Thomas J. D'Amico DICKSTEIN SHAPIRO MORIN & OSHINSKY	LLP 7. Total fee (37 CFR 3.41) \$ 40.00
Internal Address: Atty. Dkt.: M4065.0555/P555	Enclosed
Street Address:	Authorized to be charged to deposit account
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9. Statement and signature.	
To the best of my knowledge and belief, the foregoing is a true copy of the original document.	g information is true and correct and any attached copy
Thomas J. D'Amico (28,371)	June 25, 2002
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Total number of pages including cover sheet,	attachments, and documents: 3
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PATENT REEL: 013033 FRAME: 0061

Docket No.: M4065.0555/P555

Micron No.: 01-0619

ASSIGNMENT AND AGREEMENT

For value received, I, John W. Regnier, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled APPARATUS AND METHOD TO FACILITATE HIERARCHICAL NETLIST CHECKING, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

PATENT REEL: 013033 FRAME: 0062

Docket No.: M4065.0555/P555

Micron No.: 01-0619

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

	John W. Reconier
	John W. Regnier
Date: 6-17-2002	
United States of America) State of Idaho) ss.:	
County of AAA	
On this day of	, <u>2002</u> , before me , to me known to be the individual instrument, and acknowledged execution
OTAP LONG THE	Notary Public

RECORDED: 06/25/2002